

Document Page

| Technical Report | 1(3) |
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| Prepared Jacob C. Wittrock | | Checked (Sign) | Date 2005-05-31 | Rev. | Document no. |
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| Approved | Date/Sign | l | File / reference Chablis difference | ces 26050 | 5.doc |

Project 1198 Chablis, GN9120 LR Product p/n 9120-50-05

List of differences compared to existing GN9120

1 General

1.1 Purpose

This document lists the differences between the new 9120-variant Chablis and the standard variant 2G4 9120. The Chablis is being developed in project 1198.

- Chablis part number: 9120-50-05

- Spawned from part number: 9120-30-05 (2G4 micro boom, US)

2 Design differences

2.1 Mechanical differences

The mechanical differences are purely in colouring. There are no changes in metals, but in specifications of plastic materials.

| Base parts | Standard 9120 | Chablis 9120 LR |
|--------------------------|----------------------|--|
| Side panels (2 pcs.) | Silver grey, no logo | Material moulded in Matt black, logo in silver |
| Base divider (box frame) | Old style logo | No logo |

| Headset parts | Standard 9120 | Chablis 9120 LR |
|---------------|-----------------|---|
| Pivot | Old style logo | New style logo, silver |
| Accent ring | Silver metallic | Material moulded in black painted Shiny black |
| Buttons | Black POM | Light grey POM |



Technical Report

Technical Report 2(3)

Date Rev. Document no.

| Prepared | Date | Rev. | Document no. |
|-------------------|------------|------|--------------|
| Jacob C. Wittrock | 2005-05-31 | Α | - |

2.2 Electrical differences

The electrical changes cover the charging circuit and the RF output power. Because the new ATL battery only has half the capacity compared to the old one the charging current is reduced from 320 mA to 180 mA.

The variable RF output power has been fixed to approx. 6 dBm (previously 18 dBm in std. mode and 6 dBm in Low Power). The output power is determined both by sw and hw changes.

| Base and Headset parts | Standard 9120 | Chablis 9120 LR |
|------------------------|---------------|------------------|
| Headset Battery | ATL 330 mAh | ATL 170 mAh |
| | M 603028 | M 603028 Low Cap |
| Base PCBA – R302 | 4k7 ohms | 8k2 ohms |
| Base PCBA - R303 | 4k7 ohms | 10k0 ohms |
| Base PCBA - R403 | 82k0 | N.M |
| Base PCBA – R404 | 15k0 | N.M |
| Base PCBA - R475 | 10k0 | N.M |
| Base PCBA – R476 | 270R0 | N.M |
| Base PCBA – Q400 | BC847W | N.M |
| Base PCBA - C478 | N.M | 8k2 ohms |
| Remote PCBA – C480 | 8p2 farads | N.M |
| Remote PCBA – Q400 | BC847W | N.M |
| Remote PCBA – R403 | 47k0 ohms | N.M |
| Remote PCBA – R404 | 15k0 ohms | N.M |
| Remote PCBA – R475 | 12k0 ohms | N.M |
| Remote PCBA – R476 | 330R ohms | N.M |
| Remote PCBA – C478 | N.M | 12k0 ohms |

The component locations on the PCB and in the schematics are found in the 4 attached pdf documents – circled in blue: 6863-36A_rev_B_layout Chablis Diff.pdf, 6863-37A_rev_B_layout_top_bottom Chablis Diff.pdf, 6863-37A_rev_B_schematic Chablis Diff.pdf, 1591-36A_rev_B_schematic Chablis Diff.pdf.



Document Page

3(3)

Technical Report

| Prepared | Date | Rev. | Document no. |
|-------------------|------------|------|--------------|
| Jacob C. Wittrock | 2005-05-31 | Α | - |

2.3 Software changes (functional changes)

The software is changed to facilitate changes in functionality. These changes are merely reduction of the available features.

| Functional changes | Standard 9120 | Chablis 9120 LR |
|----------------------------------|-----------------------------|-----------------------------|
| Reduced range (from 100m to 30m) | High and low TX power modes | Locked in low TX power mode |
| Conference call | Enabled | Disabled |

2.4 Other changes

User material (manuals and guides) will be changed to reflect the changes done in the product. Also the new retail package is being adapted.

| Auxiliary changes | Standard 9120 | Chablis 9120 LR |
|---------------------------------|---|---------------------------------------|
| Reference guide and Quick guide | Photos show std. model | Photos updated to show Chablis |
| | Multiple languages Talk time: up to 8 | Languages reduced to Eng, Fr, and Esp |
| | hours | Talk time: up to 5½ hours |
| Packaging – box and inlay | Normal size: (LxBxH = 330x215x85 mm) | Reduced size (LxBxH = 284x185x60 mm) |
| Packaging instructions | Standard | Reflect box change |